



IMPORTANT NOTICE

10 December 2015

1. Global joint venture starts operations as WeEn Semiconductors

Dear customer,

As from November 9th, 2015 NXP Semiconductors N.V. and Beijing JianGuang Asset Management Co. Ltd established Bipolar Power joint venture (JV), **WeEn Semiconductors**, which will be used in future Bipolar Power documents together with new contact details.

In this document where the previous NXP references remain, please use the new links as shown below.

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Thank you for your cooperation and understanding,

WeEn Semiconductors



DATA SHEET

BYR29 series
Rectifier diodes
ultrafast

Product specification

September 1998



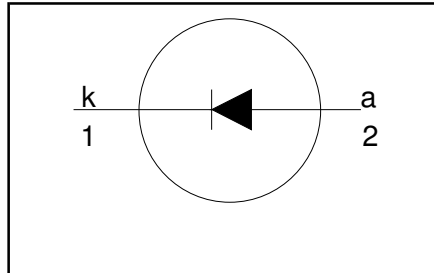
**Rectifier diodes
ultrafast**

BYR29 series

FEATURES

- Low forward volt drop
- Fast switching
- Soft recovery characteristic
- Reverse surge capability
- High thermal cycling performance
- Low thermal resistance

SYMBOL



QUICK REFERENCE DATA

| |
|---|
| $V_R = 500\text{ V} / 600\text{ V} / 700\text{ V} / 800\text{ V}$ |
| $V_F \leq 1.5\text{ V}$ |
| $I_{F(AV)} = 8\text{ A}$ |
| $t_{tr} \leq 75\text{ ns}$ |

GENERAL DESCRIPTION

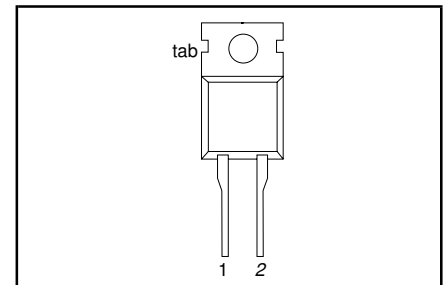
Ultra-fast, epitaxial rectifier diodes intended for use as output rectifiers in high frequency switched mode power supplies.

The BYR29 series is supplied in the conventional leaded SOD59 (TO220AC) package.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | cathode |
| 2 | anode |
| tab | cathode |

SOD59 (TO220AC)



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | | | | UNIT |
|-------------|--------------------------------------|---|------|------|------|------|------|------------------|
| | | | | -500 | -600 | -700 | -800 | |
| V_{RRM} | Peak repetitive reverse voltage | BYR29 | - | 500 | 600 | 700 | 800 | V |
| V_{RWM} | Crest working reverse voltage | | - | 500 | 600 | 700 | 800 | V |
| V_R | Continuous reverse voltage | | - | 500 | 600 | 700 | 800 | V |
| $I_{F(AV)}$ | Average forward current ¹ | square wave; $\delta = 0.5$; $T_{mb} \leq 115\text{ }^\circ\text{C}$ | - | 8 | | | | A |
| I_{FRM} | Repetitive peak forward current | $t = 25\text{ }\mu\text{s}$; $\delta = 0.5$; $T_{mb} \leq 115\text{ }^\circ\text{C}$ | - | 16 | | | | A |
| I_{FSM} | Non-repetitive peak forward current | $t = 10\text{ ms}$ | - | 60 | | | | A |
| | | $t = 8.3\text{ ms}$ | - | 66 | | | | A |
| T_{stg} | Storage temperature | sinusoidal; with reappplied $V_{RRM(max)}$ | -40 | 150 | | | | $^\circ\text{C}$ |
| T_j | Operating junction temperature | | - | 150 | | | | $^\circ\text{C}$ |

THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------|--|--------------|------|------|------|------|
| $R_{th\ j-mb}$ | Thermal resistance junction to mounting base | in free air. | - | - | 2.5 | K/W |
| $R_{th\ j-a}$ | Thermal resistance junction to ambient | | - | 60 | - | K/W |

¹ Neglecting switching and reverse current losses

Rectifier diodes
ultrafast

BYR29 series

ELECTRICAL CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------|-------------------------------|---|------|------|------|---------------|
| V_F | Forward voltage | $I_F = 8\text{ A}; T_j = 150\text{ }^\circ\text{C}$ | - | 1.07 | 1.50 | V |
| | | $I_F = 20\text{ A}$ | - | 1.75 | 1.95 | V |
| I_R | Reverse current | $V_R = V_{RRM}$ | - | 1.0 | 10 | μA |
| Q_s | Reverse recovery charge | $V_R = V_{RRM}; T_j = 100\text{ }^\circ\text{C}$ $I_F = 2\text{ A to } V_R \geq 30\text{ V};$ $di_F/dt = 20\text{ A}/\mu\text{s}$ | - | 0.1 | 0.2 | mA |
| t_{rr} | Reverse recovery time | $I_F = 2\text{ A to } V_R \geq 30\text{ V};$ $di_F/dt = 100\text{ A}/\mu\text{s}$ | - | 60 | 75 | ns |
| I_{rrm} | Peak reverse recovery current | $I_F = 10\text{ A to } V_R \geq 30\text{ V};$ $di_F/dt = 50\text{ A}/\mu\text{s}; T_j = 100\text{ }^\circ\text{C}$ | - | - | 6 | A |
| V_{fr} | Forward recovery voltage | $I_F = 10\text{ A}; di_F/dt = 10\text{ A}/\mu\text{s}$ | - | 5.0 | - | V |

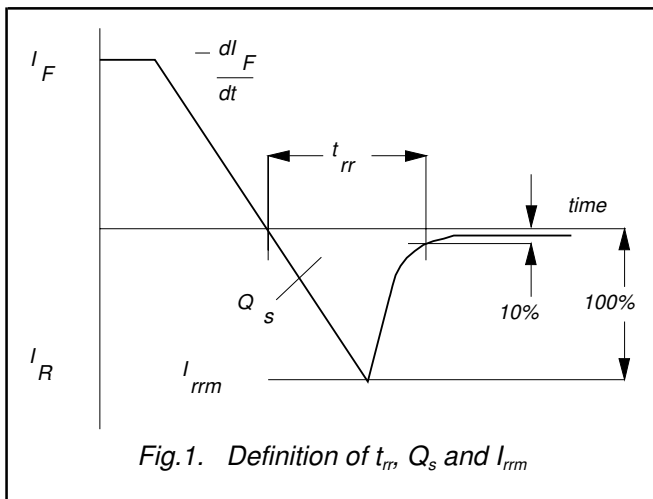


Fig.1. Definition of t_{rr} , Q_s and I_{rrm}

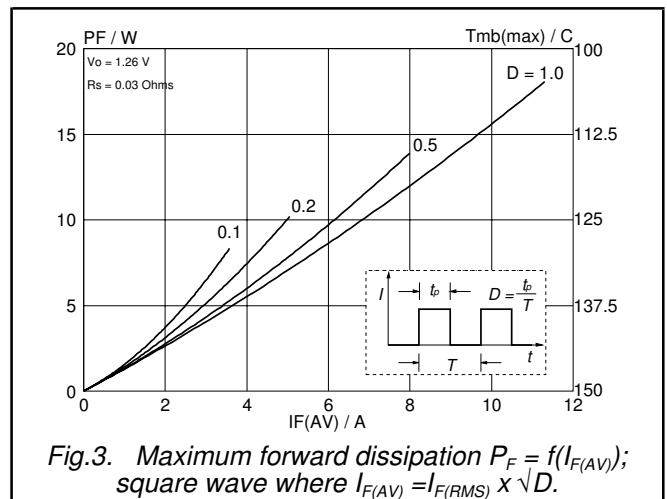


Fig.3. Maximum forward dissipation $P_F = f(I_{F(AV)})$; square wave where $I_{F(AV)} = I_{F(RMS)} \times \sqrt{D}$.

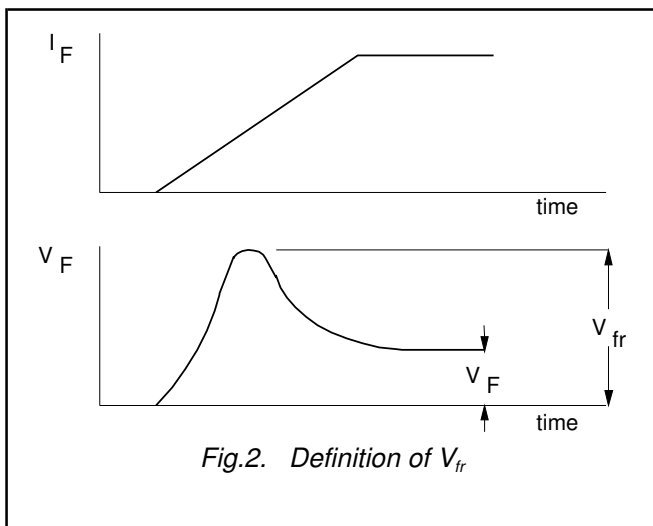


Fig.2. Definition of V_{fr}

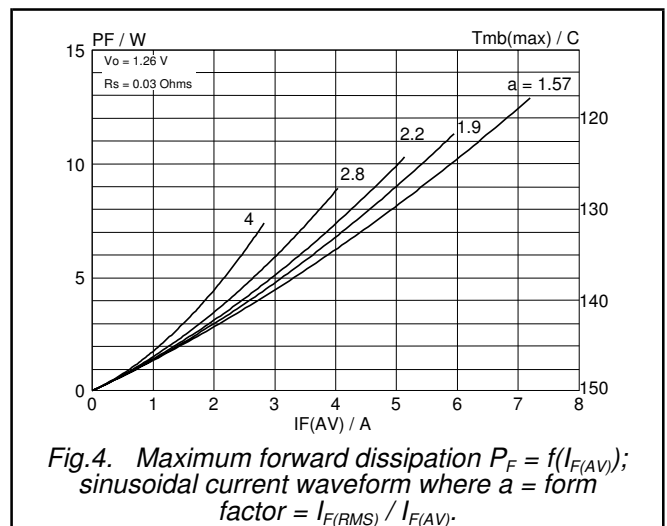


Fig.4. Maximum forward dissipation $P_F = f(I_{F(AV)})$; sinusoidal current waveform where $a = \text{form factor} = I_{F(RMS)} / I_{F(AV)}$.

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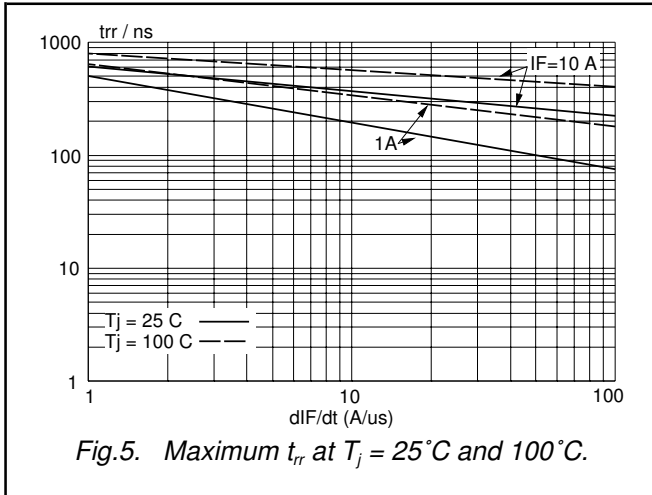


Fig.5. Maximum t_{rr} at $T_j = 25^\circ\text{C}$ and 100°C .

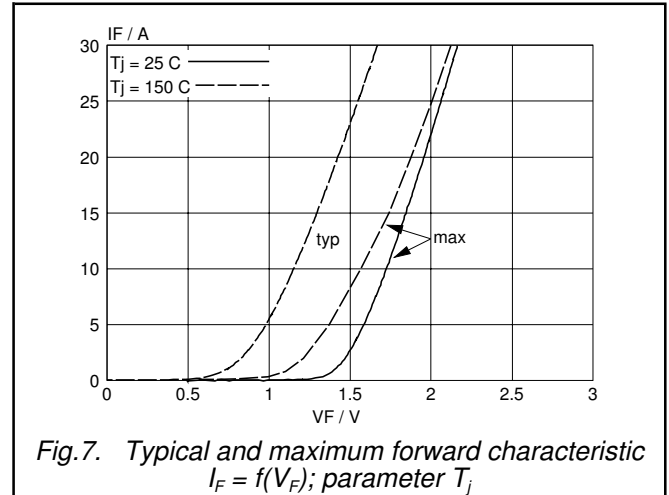


Fig.7. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_j

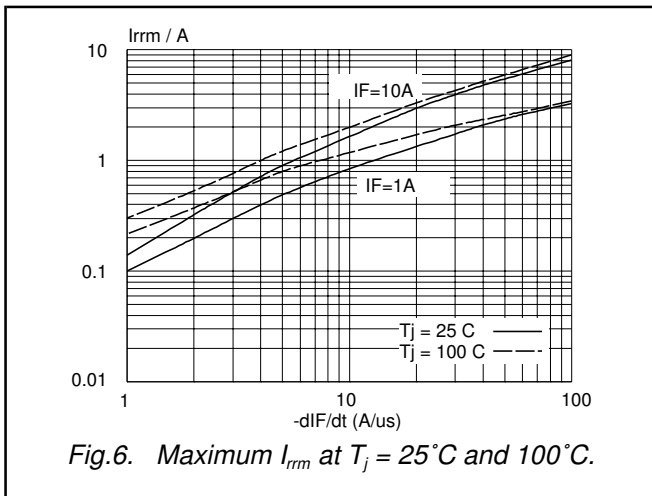


Fig.6. Maximum I_{rrm} at $T_j = 25^\circ\text{C}$ and 100°C .

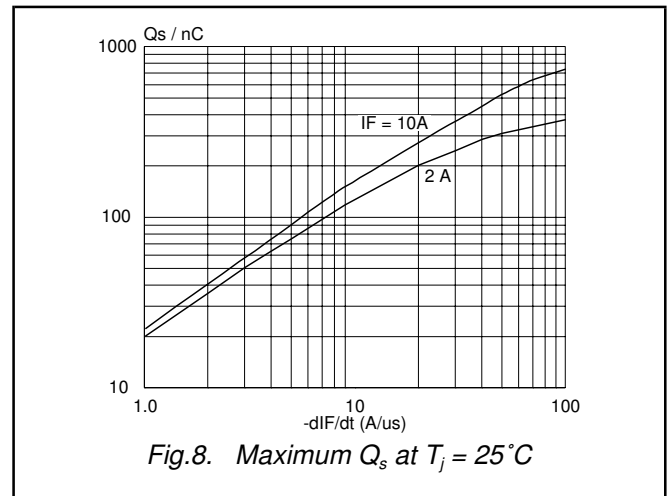


Fig.8. Maximum Q_s at $T_j = 25^\circ\text{C}$

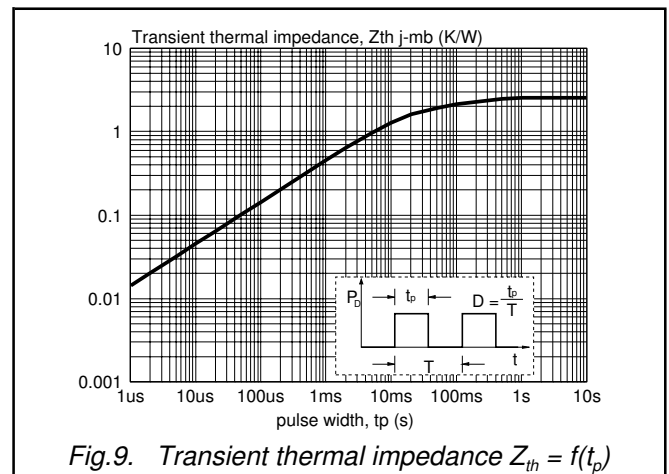


Fig.9. Transient thermal impedance $Z_{th} = f(t_p)$

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MECHANICAL DATA

Dimensions in mm

Net Mass: 2 g

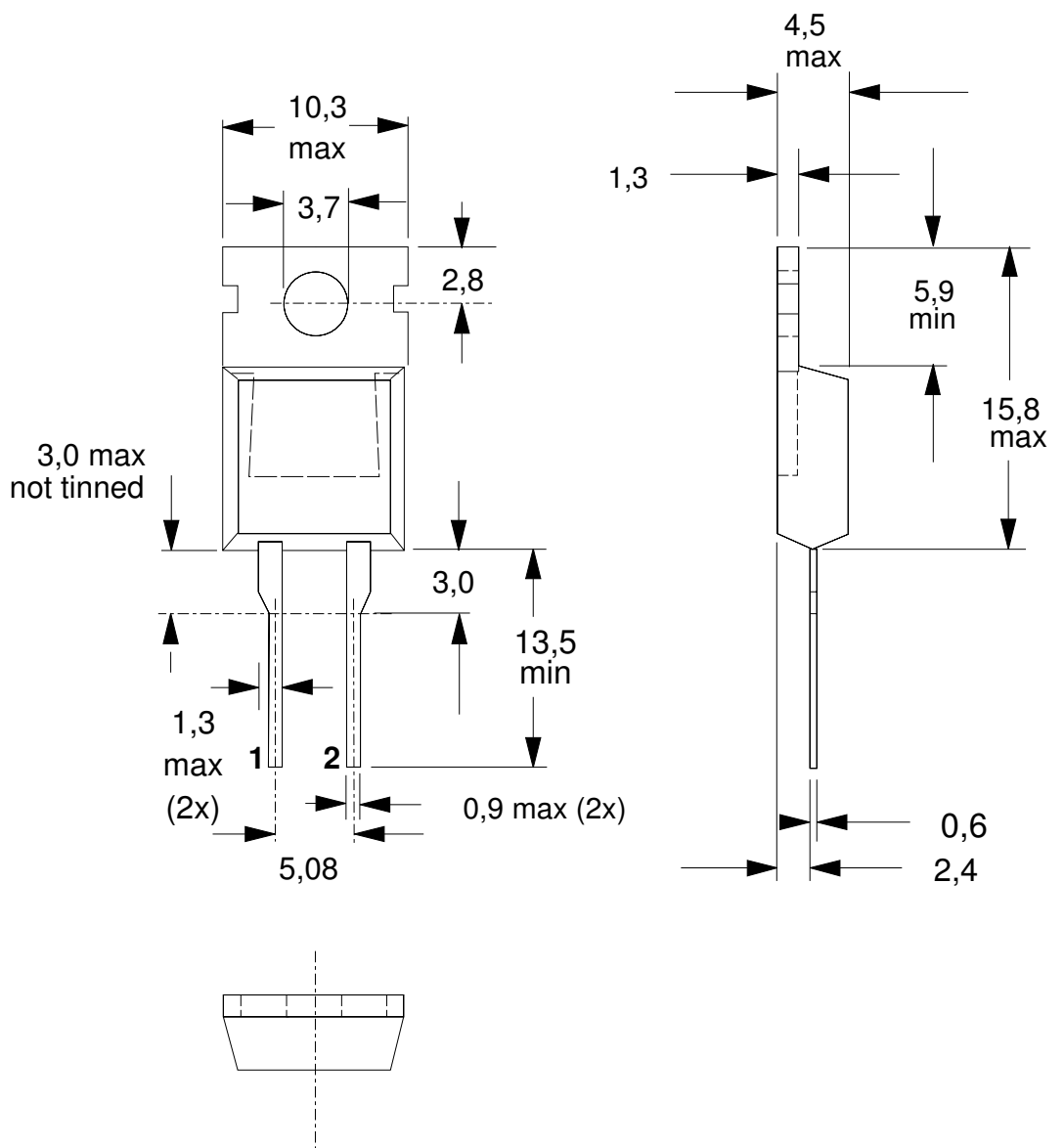


Fig.10. SOD59 (TO220AC). pin 1 connected to mounting base.

Notes

1. Refer to mounting instructions for TO220 envelopes.
2. Epoxy meets UL94 V0 at 1/8".

Legal information

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|--------------------------------|-------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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Contact information

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